PowerMOS transistor Isolated version of BUK452-60A/B

BUK472-60A/B

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic full-pack envelope.

The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in automotive and general purpose switching applications.

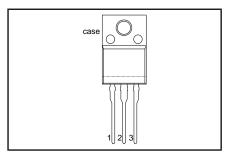
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
	BUK472	-60A	-60B	
V_{DS}	Drain-source voltage	60	60	V
l 1	Drain current (DC)	10	9.2	Α
I I _D P _{tot}	Total power dissipation	22	22	W
l Ti	Junction temperature	150	150	°C
R _{DS(ON)}	Drain-source on-state	0.13	0.15	Ω
25(5(4)	resistance			

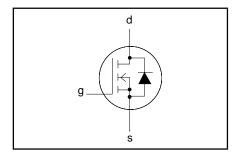
PINNING - SOT186A

PIN	DESCRIPTION
1	gate
2	drain
3	source
case	isolated

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	AX.	UNIT
V _{DS} V _{DGR} ±V _{GS}	Drain-source voltage Drain-gate voltage Gate-source voltage	$R_{GS} = 20 \text{ k}\Omega$	- - -	6	60 60 60	V V V
_D _D _{DM}	Drain current (DC) Drain current (DC) Drain current (pulse peak value)	$T_{hs} = 25 ^{\circ}C$ $T_{hs} = 100 ^{\circ}C$ $T_{hs} = 25 ^{\circ}C$	-	-60A 10 6.3 40	-60B 9.2 5.8 37	A A A
P_{tot} T_{stg} T_{j}	Total power dissipation Storage temperature Junction temperature	T _{hs} = 25 °C -	- - 55 -	1:	22 50 50	Č Č

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs}	Thermal resistance junction to heatsink	with heatsink compound	-	-	5.68	K/W
R _{th j-a}	Thermal resistance junction to ambient		-	55	-	K/W

BUK472-60A/B

STATIC CHARACTERISTICS

 T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA}$	60	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$; $I_D = 1 \text{ mA}$	2.1	3.0	4.0	V
I _{DSS}	Zero gate voltage drain current	$V_{DS} = 60 \text{ V}$: $V_{CS} = 0 \text{ V}$: $T_1 = 25 \text{ °C}$	-	1	10	μΑ
I _{DSS}	Zero gate voltage drain current	$ V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}; T_i = 125 \text{ °C}$	-	0.1	1.0	mΑ
I _{GSS}	Gate source leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
R _{DS(ON)}	Drain-source on-state	$V_{GS} = 10 \text{ V};$ BUK472-60A	-	0.11	0.13	Ω
==(514)	resistance	$I_D = 8.5 \text{ A}$ BUK472-60B	-	0.13	0.15	Ω

DYNAMIC CHARACTERISTICS

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g _{fs}	Forward transconductance	$V_{DS} = 25 \text{ V}; I_{D} = 8.5 \text{ A}$	3.5	4.7	ı	S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$	1 1 1	400 150 70	500 200 100	pF pF pF
$t_{d \text{ on}} \ t_{r} \ t_{d \text{ off}} \ t_{f}$	Turn-on delay time Turn-on rise time Turn-off delay time Turn-off fall time	$ \begin{aligned} V_{\text{DD}} &= 30 \text{ V; } I_{\text{D}} = 3 \text{ A;} \\ V_{\text{GS}} &= 10 \text{ V; } R_{\text{GS}} = 50 \Omega; \\ R_{\text{gen}} &= 50 \Omega \end{aligned} $	- - -	8 25 30 30	14 45 45 45	ns ns ns ns
L _d L _s	Internal drain inductance Internal source inductance	Measured from drain lead 6 mm from package to centre of die Measured from source lead 6 mm from package to source bond pad	-	4.5 7.5	1 1	nH nH

ISOLATION LIMITING VALUE & CHARACTERISTIC

T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	ı		2500	>
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	ı	10	ı	pF

REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

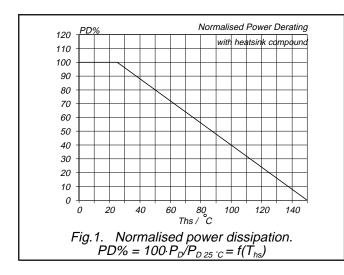
T_{hs} = 25 °C unless otherwise specified

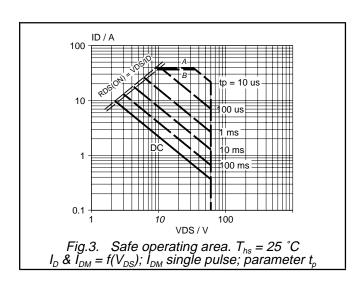
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{DR}	Continuous reverse drain current	-	-	-	10	А
$oldsymbol{I_{DRM}}{oldsymbol{V_{SD}}}$	Pulsed reverse drain current Diode forward voltage	$I_F = 10 \text{ A}$; $V_{GS} = 0 \text{ V}$	1 1	- 1.4	40 1.7	A V
t _{rr} Q _{rr}	Reverse recovery time Reverse recovery charge	$I_F = 10 \text{ A}$; $-dI_F/dt = 100 \text{ A}/\mu\text{s}$; $V_{GS} = 0 \text{ V}$; $V_R = 30 \text{ V}$	-	60 0.15	-	ns μC

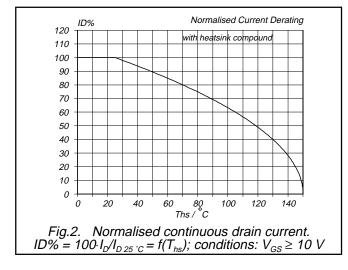
AVALANCHE LIMITING VALUE

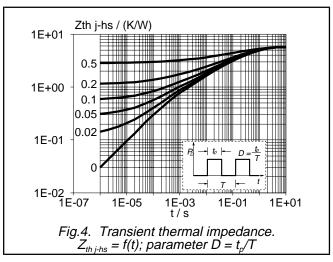
T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
W _{DSS}	Drain-source non-repetitive unclamped inductive turn-off energy	$\begin{split} I_D &= 15 \text{ A ; } V_{DD} \leq 30 \text{ V ;} \\ V_{GS} &= 10 \text{ V ; } R_{GS} = 50 \Omega \end{split}$	1	1	30	mJ

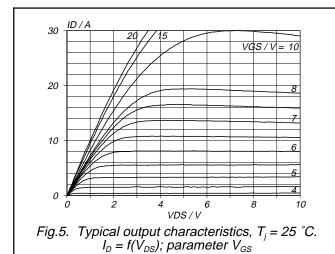


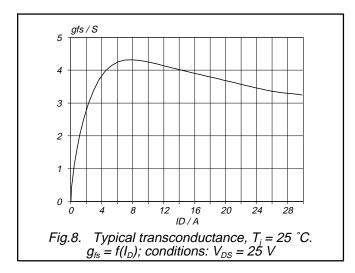


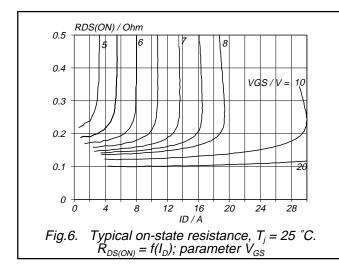


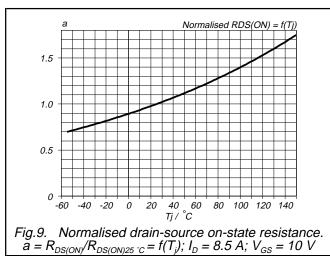


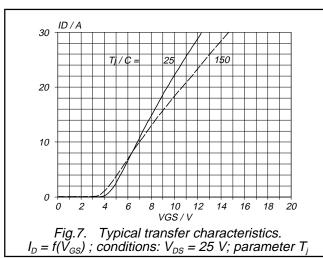
BUK472-60A/B

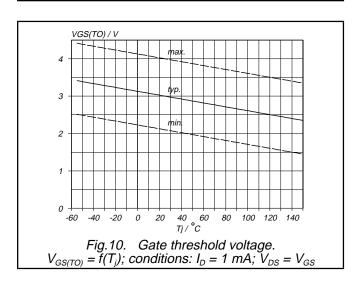




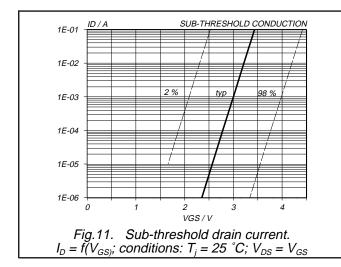


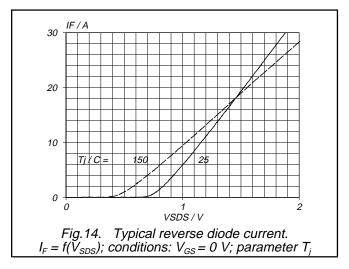


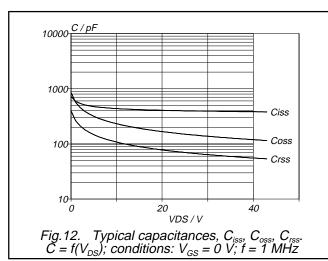


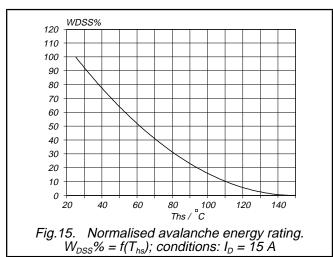


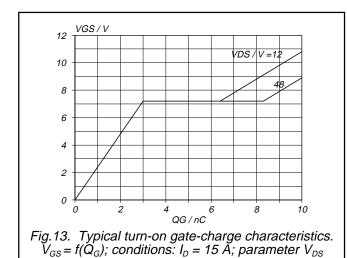
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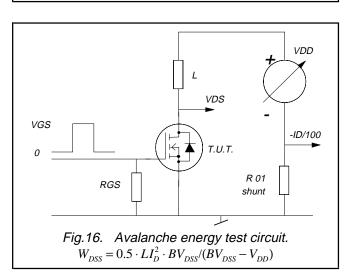






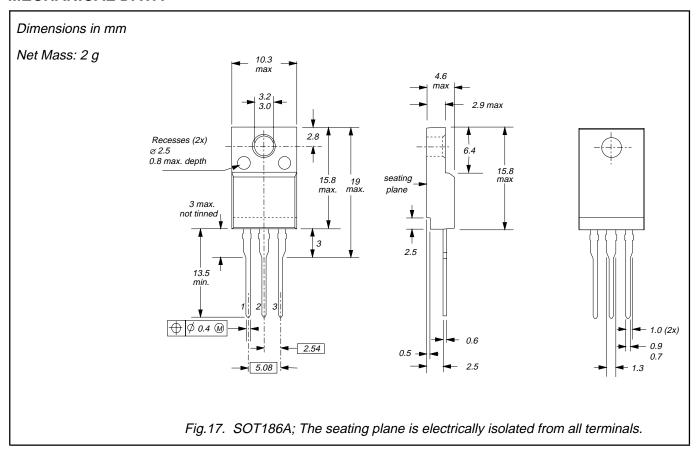






BUK472-60A/B

MECHANICAL DATA



Notes

- Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
 Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

BUK472-60A/B

DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification This data sheet contains preliminary data; supplementary data may be published					
Product specification This data sheet contains final product specifications.					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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